

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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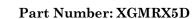
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SunLED www.SunLEDusa.com

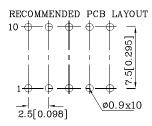
BAR GRAPH 5 SEGMENT

Features

- Robust package
- Uniform light disbursement
- Ideal for backlighting logos or icons
- Excellent for flush mounting
- Standard configuration: Gray face w/ white segments
- RoHS compliant



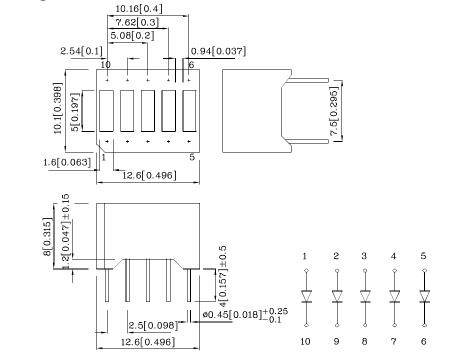






ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Package Schematics



Notes.

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted. 2. Specifications are subject to change without notice.

| Absolute Maximum Ratings (T _A =25°C) | Red (GaAlAs) | Unit | | |
|--|-----------------------|-----------|----|--|
| Reverse Voltage | V_{R} | 5 | V | |
| Forward Current | I_{F} | 30 | mA | |
| Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width | ifs | 155 | mA | |
| Power Dissipation | P_{D} | 75 | mW | |
| Operating Temperature | T_{A} | -40 ~ +85 | °C | |
| Storage Temperature | Tstg | -40 ~ +85 | | |
| Lead Solder Temperature [2mm Below Package Base] | 260°C For 3-5 Seconds | | | |

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

| Operating Characteristics (T _A =25°C) | Red (GaAlAs) | Unit | |
|--|------------------|------|----|
| Forward Voltage (Typ.) (I _F =10mA) | V_{F} | 1.8 | V |
| Forward Voltage (Max.) (I _F =10mA) | V_{F} | 2.5 | V |
| Reverse Current (Max.) $(V_R=5V)$ | I_R | 10 | uA |
| Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA) | λР | 655* | nm |
| Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$ | λD | 640* | nm |
| Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA) | Δλ | 20 | nm |
| Capacitance (Typ.) (V _F =0V, f=1MHz) | С | 45 | pF |

| Part Number | Emitting Color | Emitting Material | CIE127-2007* (I _F =10mA) ucd | | Wavelength CIE127-2007* nm λP | Description |
|--------------------|-------------------|----------------------|---|-----------------|-------------------------------------|--------------------------------|
| | | | min. | typ. | | |
| XGMRX5D | Red | GaAlAs | 14000 3600* | 29990* 7990* | 655* | 5 Segment Bar graph-Display |

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

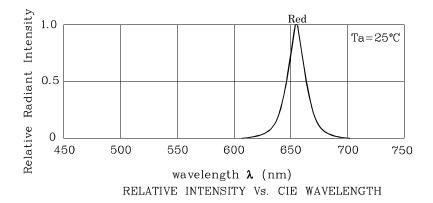
Oct 17,2016

XDSA6044 V6-X Layout: Maggie L.

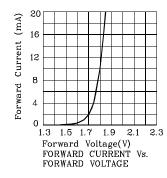
BAR GRAPH 5 SEGMENT

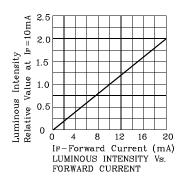


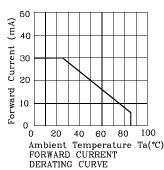


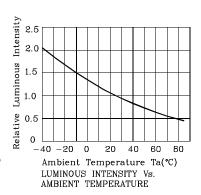


❖ Red

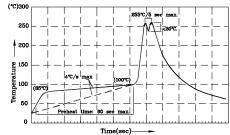








Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- max).
 3.Do not apply stress to the epoxy resin while the temperature is a
 4.Fixtures should not incur stress on the component when mounting
 during soldering process.
 5.SAC 305 solder alloy is recommended.
 6.No more than one wave soldering pass.
 7.During wave soldering, the PCB top-surface temperature should be
 kept below 105°C.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

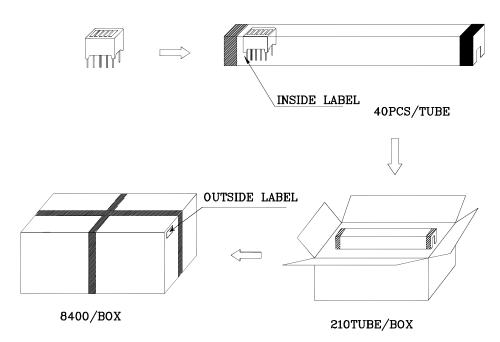
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

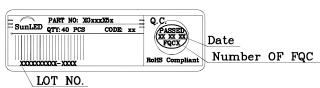


ber: XGMKX5D + 5 SEGMENT

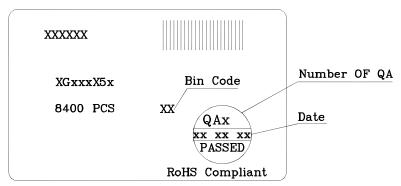
PACKING & LABEL SPECIFICATIONS



Inside Label On IC-tube



Outside Label On Box



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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

Oct 17,2016